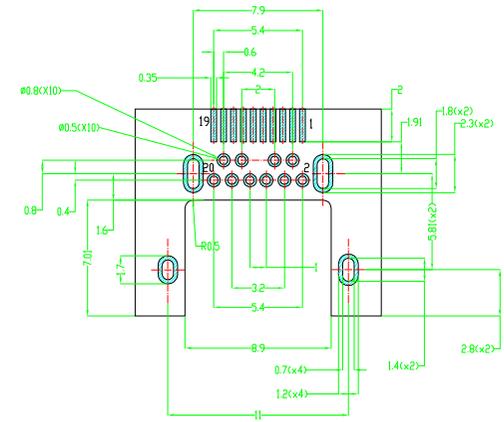
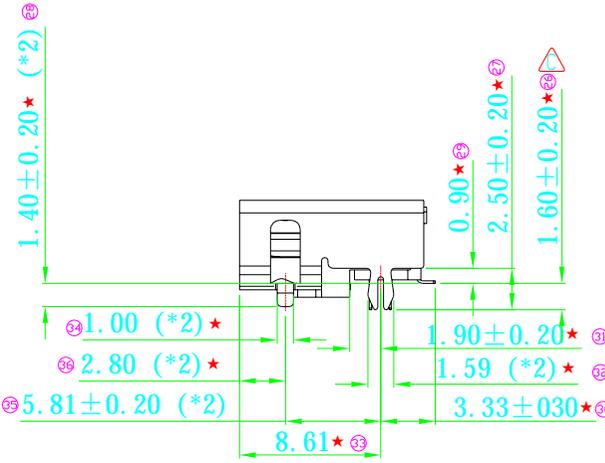
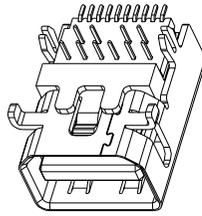
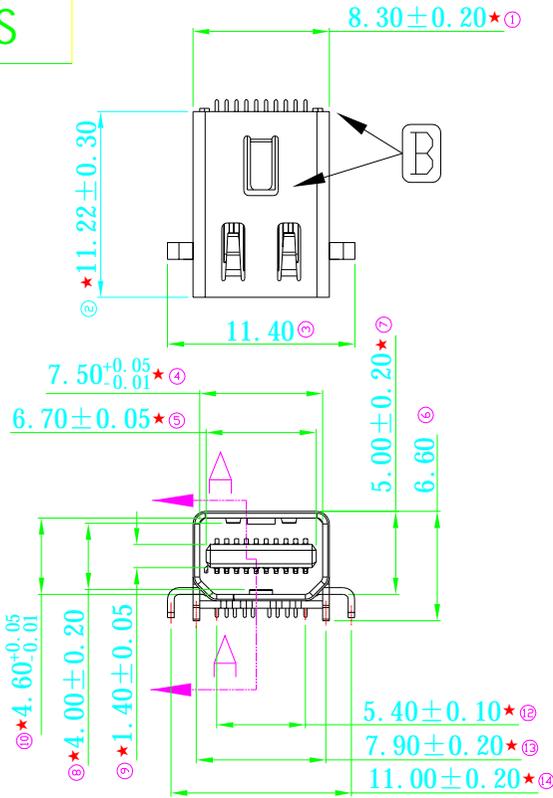


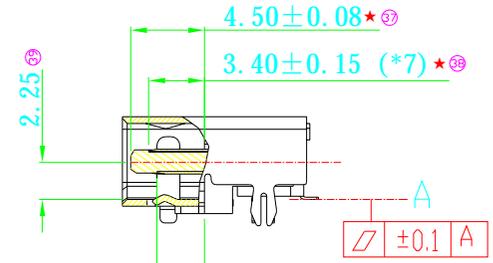
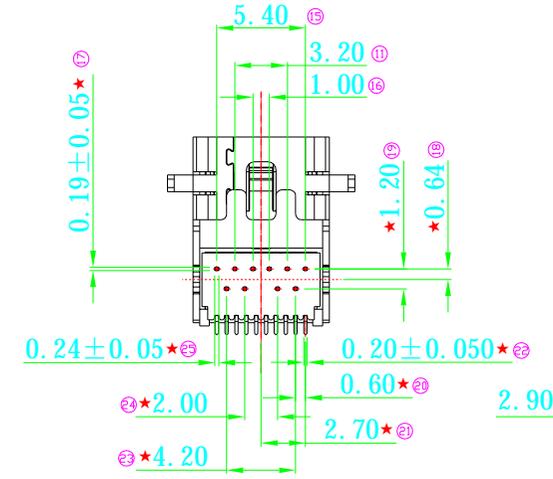
ECN NO.	REV.	DATA	APPLY BY	DESCRIPTION
130717	C	袁玉庭	2013-07-13	应客户要求变更DIP脚长度

RoHS



PCB LAYOUT

- NOTES:
- MATERIAL :
HOUSING: HIGH TEMPERATURE THERMOPLASTIC,UL94V-0, COLOR: BLACK
CONTACT: COPPER ALLOY
SHELL: STAINLESS STEEL
 - FINISH:
CONTACT: NICKEL PLATING OVERALL,
GOLD PLATING ON CONTACT AREA & MATT
TIN PLATING OVER NICKEL ON SOLDER TAIL
SHELL: NICKEL PLATED OVERALL
 - IR REFLOW TEMPERATURE: 260°C FOR 10 SECONDS 3CYCLES.



TOLERANCE			DATE: 2013/07/13
SELECT	TOL		DR:
NO		1 2 3	
0.000+/-	0.02	0.05 0.10	
0.00 +/-	0.05	0.10 0.15	
0.0 +/-	0.10	0.15 0.20	
0 +/-	0.15	0.20 1.00	
ANGLE+/-	1	1 1.5	

BossConn

TITLE: 品名 **MINI DP沉板式母座**

PART NO: **MDP-F-CN02**

UNIT	SCALE	REV.	PAGE
MM	1:1	C	1/1

由 Autodesk 教育版产品制作

由 Autodesk 教育版产品制作